



## Sensor Technologies for Intelligent Transportation Systems

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### Message from the Guest Editors

Dear Colleagues,

This Special Issue is dedicated to showcasing cutting-edge research and developments in sensor technologies that can be integrated into ITSs to address these challenges. Contributions may include studies on the use of various types of sensors such as LiDAR, radar, ultrasonic, camera, and thermal sensors, as well as the role of the Internet of Things (IoT) in enhancing sensor capabilities within ITS. Through this collection of high-quality research articles, we hope to foster the development of smarter, safer, and more efficient transportation systems for the future.

Topics of interests include, but are not limited to, the following:

1. Multi-sensor fusion for intelligent transportation system localization, including GNSS, IMU, LiDAR, camera, and high-definition map.
2. The integration of sensor data with vehicular and infrastructural systems.
3. Sensor-based predictive maintenance for transportation infrastructure
4. The application of machine learning and artificial intelligence in processing sensor data
5. The reliability and accuracy of sensor data study





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## Editor-in-Chief

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## Message from the Editor-in-Chief

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